

Engineer Drawing

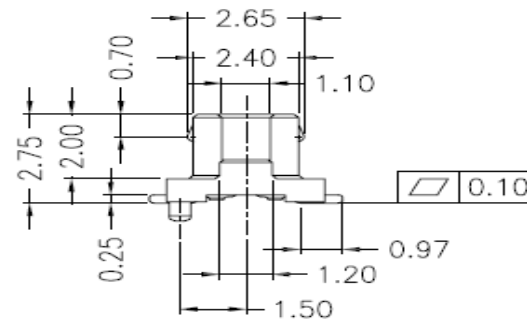
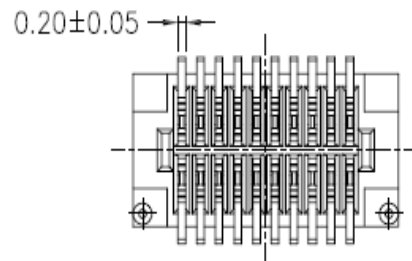
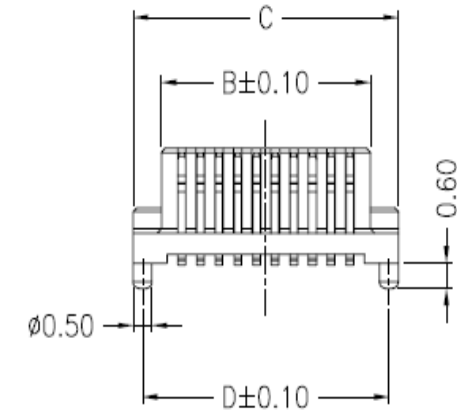
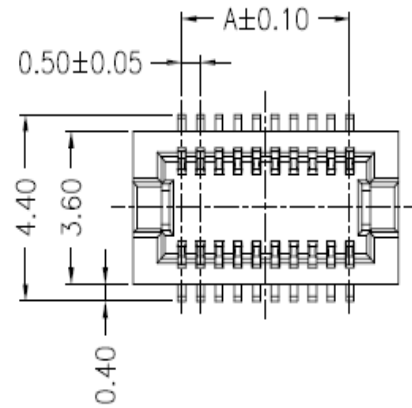
1.MATERIAL:

Insulator: High Temperature Thermoplastic,UL 94V-0

Contact: Copper Alloy

2.PLATING:

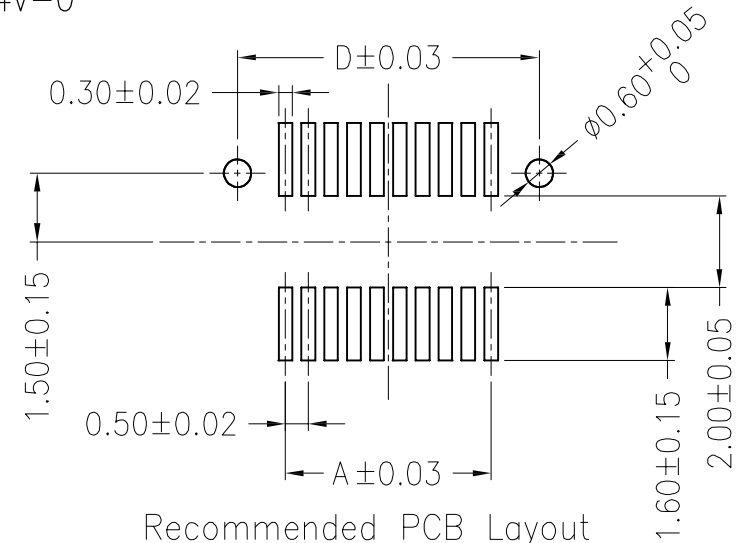
Contact: 50u" Ni UnderPlating Over all
1u" Gold Plating Over all



IPCB05501 * ** * * *

① ② ③ ④ ⑤ ⑥

- ① Series Type ④ Serial code
② Type ⑤ Company code.
③ Pin code. ⑥ Serial code



Recommended PCB Layout

CKT.	A	B	C	D
10	2.00	3.10	4.60	4.10
20	4.50	5.60	7.10	6.60
30	7.00	8.10	9.60	9.10
36	8.50	9.60	11.10	10.60
40	9.50	10.60	12.10	11.60
50	12.00	13.10	14.60	14.10
60	14.50	15.60	17.10	16.60
68	16.50	17.60	19.10	18.60
70	17.00	18.10	19.60	19.10
80	19.50	20.60	22.10	21.60

TOLERANCE

X ±0.5 XX ±0.25
X ±0.35 XXX ±0.15
ANGLES ± 0.3°

UNLESS OTHERWISE SPECIFIED

NCP

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PART NO.
IPCB05501 xx

DRAWING NO.
IPCB05501

TITLE:
0.5mm Borad to Borad H=5.0mm
male



SHEET 1 OF 1

UNITS mm

SCALE 1:1

REV. 01

单击下面可查看定价，库存，交付和生命周期等信息

[>>INCP](#)